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T520A226M006ATE100

T520, Tantalum, Polymer Tantalum, 22 uF, 20%, 6.3 VDC, SMD, Polymer, Molded, Low ESR, Non-Combustible, 100 mOhms, 3216, Height Max = 1.8mm

CATHODE (-) END VIEW For T520 Series, bevel is at KEMET's option ANODE (+) END VIEW BOTTOM VIEW Termination cutout at KEMET's option, either end

Dimensions	
Footprint	3216
L	3.2mm +/-0.2mm
W	1.6mm +/-0.2mm
Н	1.6mm +/-0.2mm
Т	0.13mm REF
S	0.8mm +/-0.3mm
F	1.2mm +/-0.1mm
Α	1.2mm MIN
Р	0.4mm REF
R	0.4mm REF
X	0.1mm +/-0.1mm

Packaging Specifications		
Weight	53.16 mg	
Packaging	T&R, 178mm	
Packaging Quantity	2000	

General Information		
Series	T520	
Dielectric	Polymer Tantalum	
Style	SMD Chip	
Description	SMD, Polymer, Molded, Low ESR, Non-Combustible	
Features	LowESR	
RoHS	Yes	
Termination	Tin	
AEC-Q200	No	
Shelf Life	52 Weeks	
MSL	3	

Specifications		
Capacitance	22 uF	
Capacitance	20%	
Tolerance	20%	
Voltage DC	6.3 VDC (105C)	
Temperature	FF /:10F0C	
Range	-55/+105°C	
Rated	10500	
Temperature	105°C	
Humidity	60C, 90% RH, 500 Hours, No Load	
Dissipation Factor	8% 120Hz 25C	
Failure Rate	N/A	
Resistance	100 mOhms (100kHz 25C)	
Ripple Current	1100 mA (rms, 100kHz 45C), 770 mA (rms,	
	85C), 275 mA (rms, 105C)	
Leakage Current	13.9 uA (5min 25°C)	

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

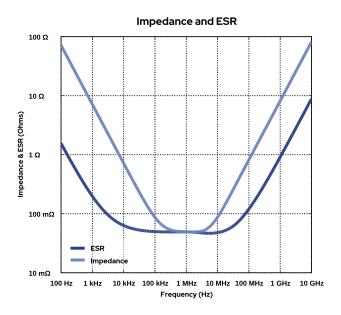


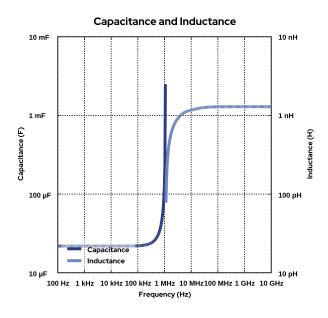
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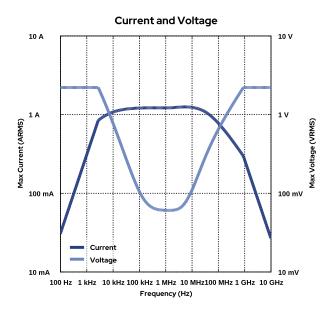
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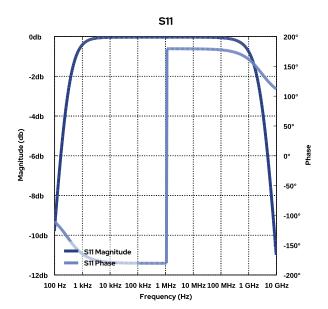
Simulations

For the complete simulation environment please visit K-SIM.





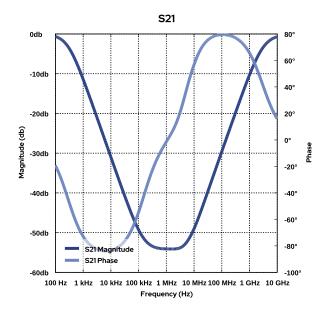






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These are simulations

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- · The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- · Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

All Information given herein is believed to be accurate and reliable, but is presented without guarantee, warranty, or responsibility of any kind, expressed or implied. Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application.

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If you have any questions please contact K-SIM.